



a day, Kdi ec f he C m a, Kbe a di he eb, Ka h i ed d, a. ead a ac  
all, ch ac a d hi g a he/ he ma, Ki hi /he di c ei c ide ece a, Kde i able  
e. edie i c eci he e i h.-”

B, K de f he B a d f  
**Kingboard Chemical Holdings Limited**  
**LO Ka Leong**  
*Company Secretary*

H g K g, 28 N embe 2013

*Hong Kong head office and principal place of business:*

2/F., Ha b i Vie l  
N . 12 Scie ce Pa k Ea A e i e  
Pha e 2 H g K g Scie ce Pa k  
Sha i , Ne Te i ie  
H g K g

*Notes:*

1. A, K ha eh lde f he C m a, Ke i led a e d a d e a he mee i g c e ed b, K he ab e ice  
i e i led a. i e m e. ie a e d a d e i hi ead. A. K eed be a  
ha eh lde .
2. Whe e he e a e j i egi e ed h lde f a, K ha e i he i , ed ha e ca i al f he C m a, K a, K e  
f i ch. e ma, K e a he mee i g, ei he . e all, K b, K. K i e. ec f i ch ha e a if  
he/ he/ i e e le, Ke i led he e . B if m e ha e f i ch j i h lde be. e e a he mee i g  
. e all, K b, K. K ha e f he aid. e . e e h e ame a d fi he egi e f  
membe f he C m a, K (Regi e f Membe -) i e. ec f i ch ha e hall al e bee i led e  
i e. ec he e f.
3. I de be alid, a f m f. K ge he i ha. e fa e, K he a h i, K i f a, K i de  
hich i i ig ed a a ial, K ce ified c. K f ha. e fa e, K a h i, K m be de i ed  
i h he C m a, K b a ch ha e egi a i H g K g, Tic Sec e a ie Limi ed, a 26/F., Te b, K  
Ce e, 28 Q ee ' R ad Ea , Wa ch ai, H g K g, le ha 48 h i bef e he ime a. i ed f  
h ldi g he mee i g a, K adj i ed mee i g a he ca e ma, K be.
4. A a he da e he e f, he b a d f di ec f he C m a, K c i f Me Cha g K k Wi g,  
Cha g Wi g Yi , Cha g K g K a , H Yi Sa g, Cha g Wai Li , Se ha ie, M k Cham H g,  
Chad ick a d Che Ma he g, bei g he e ea i e di ec , M Cha Wi g K a , bei g he  
-e ea i e di ec a d Me Che g Wai Chee, Ch i . he , Ta g Ki g Shi g, Lai Ch g Wi g,  
R be a d T e Kam H g, bei g he i de e de -e ea i e di ec .